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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
09/964,693	09/28/2001	Kenji Watanabe	Q66444	2941
7590 12/19/2005			EXAMINER	
SUGHRUE, MION, ZINN, MACPEAK & SEAS, PLLC			KRUER, KEVIN R	
2100 Pennsylva Washington, D	nnia Avenue, N.W.		ART UNIT	PAPER NUMBER
washington, D	20051		1773	

DATE MAILED: 12/19/2005

Please find below and/or attached an Office communication concerning this application or proceeding.

			A				
	Application No.	Applicant(s)					
Office Assistant Commencer	09/964,693	WATANABE ET AL.					
Office Action Summary	Examiner	Art Unit					
	Kevin R. Kruer	1773					
The MAILING DATE of this communication ap Period for Reply	ppears on the cover sheet	with the correspondence address					
A SHORTENED STATUTORY PERIOD FOR REPL THE MAILING DATE OF THIS COMMUNICATION.  - Extensions of time may be available under the provisions of 37 CFR 1. after SIX (6) MONTHS from the mailing date of this communication.  - If the period for reply specified above, is less than thirty (30) days, a rep. If NO period for reply is specified above, the maximum statutory produce.  - Failure to reply within the set or extended period for reply will, by statut Any reply received by the Office later than three months after the mailing earned patent term adjustment. See 37 CFR 1.704(b).	136(a). In no event, however, may ply within the statutory minimum of the d will apply and will expire SIX (6) Middle, cause the application to become	a reply be timely filed  nirty (30) days will be considered timely.  DNTHS from the mailing date of this communication  ABANDONED (35 U.S.C. & 133).	1.				
Status							
1) Responsive to communication(s) filed on 26.5	Sentember 2005						
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3) Since this application is in condition for allows	· · · · · · · · · · · · · · · · · · ·						
Disposition of Claims							
4) ☐ Claim(s) 2,19-21,23 and 24 is/are pending in 4a) Of the above claim(s) is/are withdra 5) ☐ Claim(s) is/are allowed. 6) ☐ Claim(s) 2,19-21,23 and 24 is/are rejected. 7) ☐ Claim(s) is/are objected to. 8) ☐ Claim(s) are subject to restriction and/or	awn from consideration.						
Application Papers							
9) The specification is objected to by the Examination							
10) ☐ The drawing(s) filed on is/are: a) ☐ acc							
Applicant may not request that any objection to the							
Replacement drawing sheet(s) including the correct 11) The oath or declaration is objected to by the E			l).				
Priority under 35 U.S.C. § 119							
a) Acknowledgment is made of a claim for foreign a) All b) Some * c) None of:  1. Certified copies of the priority documen 2. Certified copies of the priority documen 3. Copies of the certified copies of the priority application from the International Burea * See the attached detailed Office action for a list	nts have been received.  Its have been received in brity documents have been au (PCT Rule 17.2(a)).	Application No n received in this National Stage					
Attachment(s)							
1) Notice of References Cited (PTO-892) 2) Notice of Draftsperson's Patent Drawing Review (PTO-948) 3) Information Disclosure Statement(s) (PTO-1449 or PTO/SB/08 Paper No(s)/Mail Date	Paper No	Summary (PTO-413) s)/Mail Date Informal Patent Application (PTO-152)					

#### **DETAILED ACTION**

#### Continued Examination Under 37 CFR 1.114

1. A request for continued examination under 37 CFR 1.114, including the fee set forth in 37 CFR 1.17(e), was filed in this application after final rejection. Since this application is eligible for continued examination under 37 CFR 1.114, and the fee set forth in 37 CFR 1.17(e) has been timely paid, the finality of the previous Office action has been withdrawn pursuant to 37 CFR 1.114. Applicant's submission filed on September 26, 2005 has been entered.

## Specification

2. The lengthy specification has not been checked to the extent necessary to determine the presence of all possible minor errors. Applicant's cooperation is requested in correcting any errors of which applicant may become aware in the specification.

### Claim Rejections - 35 USC § 103

- 3. The text of those sections of Title 35, U.S. Code not included in this action can be found in a prior Office action.
- 4. Claims 2, 19-21, and 24 are rejected under 35 U.S.C. 103(a) as being unpatentable over JP20001192520A (herein referred to as Watanabe'520) in view of Yoshizumi (US 4,431,764).

Watanabe'520 teaches a molded material consisting of a flame retardant vinyl chloride resin molded material. The molded material may comprise a substratum (herein understood to read on the claimed "base layer") and a surface layer (herein

relied upon to read on the claimed "intermediate layer") on at least one side thereof (paragraph 0153). The substratum comprises 100pbw vinyl chloride based resin having a degree of chlorination of from 58-73% (0153). Said substratum may comprise a zinc or tin fire retardant (00153). The amount of fire retardant utilized should be controlled in order to obtain the desired transparency (00132). Since said teaching is silent with regards to the addition of titanium dioxide to said substratum and since the laminate is taught to be transparent, it is herein understood said substratum is "free of any titanium compound." Said substratum layer is taught to preferably have a thickness of 2-14mm (0151). The surface layer comprises 100pbw vinyl chloride based resin that has a chlorination degree of 56% (0153). The surface layer has a thickness of 0.4-2mm (paragraph 0153). Since said teaching is silent with regards to the addition of titanium dioxide to said surface layers and since the laminate is taught to be transparent, it is herein understood said surface layers "free of any titanium compound." The molded material is utilized in semiconductor fabrication machines and equipment.

Watanabe'520 does not teach that the molded object may be coated on one side with an antistatic composition. However, Yoshizumi teaches an antistatic coating composition comprising tin oxide (abstract) that is coated onto nonconductive coatings that need antistatic properties (col 1, lines 11+). The tin oxide is dispersed in a binder resin such as vinyl chloride or a thermosetting resin (col 2, lines 41+). Thus, it would have been obvious to one of ordinary skill in the art at the time the invention was made to apply the coating taught in Yoshizumi onto the substrate taught in Watanabe'520.

The motivation for doing so would have been to provide the substrate with antistatic properties.

With respect to the chlorination degree of the intermediate layer claimed in claim 2 and the chlorination degree of the antistatic layer claimed in claim 19, the references do not teach the claimed chlorination content of the vinyl chloride binders. However, Watanabe'520 teaches that the chlorination degree of a polymer will affect is fire resistance, thermal stability, and moldability. Therefore, it would have been obvious to one of ordinary skill in the art at the time the invention was made to control the chlorination degree of the vinyl chloride binder of the intermediate and antistatic layers. The motivation for doing so would have been to control the laminate's moldability, thermal stability, and fire resistance.

With regards to claim 24, neither reference teaches the desired thickness of the antistatic layer. However, Yoshizumi teaches the thickness of an antistatic layer will vary depending upon the required antistatic effect, coating strength and other requirements (col 4, lines 31+). Thus, it would have been obvious to one of ordinary skill in the art at the time the invention was made to vary the thickness of the antistatic layer taught by Yoshizumi. The motivation for doing so would have been to control the required antistatic effect, coating strength and other requirements of the laminate.

5. Claims 2 is rejected under 35 U.S.C. 103(a) as being unpatentable over JP20001192520A (herein referred to as Watanabe'520) in view of Holley (US 5,508,343).

Watanabe'520 teaches a molded material consisting of a flame retardant vinyl chloride resin molded material. The molded material may comprise a substratum (herein understood to read on the claimed "base layer") and a surface layer (herein relied upon to read on the claimed "intermediate layer") on at least one side thereof (paragraph 0153). The substratum comprises 100pbw vinyl chloride based resin having a degree of chlorination of from 58-73% (0153). Said substratum may comprise a zinc or tin fire retardant (00153). The amount of fire retardant utilized should be controlled in order to obtain the desired transparency (00132). Since said teaching is silent with regards to the addition of titanium dioxide to said substratum and since the laminate is taught to be transparent, it is herein understood said substratum is "free of any titanium" compound." Said substratum layer is taught to preferably have a thickness of 2-14mm (0151). The surface layer comprises 100pbw vinyl chloride based resin which has a chlorination degree of 56% (0153). The surface layer has a thickness of 0.4-2mm (paragraph 0153). Since said teaching is silent with regards to the addition of titanium dioxide to said surface layers and since the laminate is taught to be transparent, it is herein understood said surface layers "free of any titanium compound." The molded material is utilized in semiconductor fabrication machines and equipment.

Watanabe'520 does not teach that the molded object may be coated on one side with an antistatic composition. However, Holley teaches an antistatic composition comprising a water-soluble polymer, a titanate, and an ammonium salt (abstract). The composition is coated on substrates (col 2, lines 47+) such as object utilized in the production of semiconductor electronics (col 1, lines 14+) in order to prevent damage

that can be caused by static build-up (col 1, lines 27+). NOTE: the molded objects of Watanabe can be utilized in equipment to make semiconductors. Thus, it would have been obvious to one of ordinary skill in the art at the time the invention was made to coat the molded object taught in Watanabe '520 with the anti-static composition taught in Holley. The motivation for doing so would have been to prevent damage to semiconductor electronics that could come in contact with said object.

With respect to the chlorination degree of the intermediate layer claimed in claim 2, Watanabe does not teach the claimed chlorination content of the vinyl chloride binder. However, Watanabe'520 teaches that the chlorination degree of a polymer will affect is fire resistance, thermal stability, and moldability. Therefore, it would have been obvious to one of ordinary skill in the art at the time the invention was made to control the chlorination degree of the vinyl chloride binder of the intermediate layers. The motivation for doing so would have been to control the laminate's moldability, thermal stability, and fire resistance.

6. Claims 2 and 24 are rejected under 35 U.S.C. 103(a) as being unpatentable over JP20001192520A (herein referred to as Watanabe'520) in view of JP 11353947A(herein referred to as Sakai).

Watanabe'520 teaches a molded material consisting of a flame retardant vinyl chloride resin molded material. The molded material may comprise a substratum (herein understood to read on the claimed "base layer") and a surface layer (herein relied upon to read on the claimed "intermediate layer") on at least one side thereof (paragraph 0153). The substratum comprises 100pbw vinyl chloride based resin having

a degree of chlorination of from 58-73% (0153). Said substratum may comprise a zinc or tin fire retardant (00153). The amount of fire retardant utilized should be controlled in order to obtain the desired transparency (00132). Since said teaching is silent with regards to the addition of titanium dioxide to said substratum and since the laminate is taught to be transparent, it is herein understood said substratum is "free of any titanium compound." Said substratum layer is taught to preferably have a thickness of 2-14mm (0151). The surface layer comprises 100pbw vinyl chloride based resin which has a chlorination degree of 56% (0153). The surface layer has a thickness of 0.4-2mm (paragraph 0153). Since said teaching is silent with regards to the addition of titanium dioxide to said surface layers and since the laminate is taught to be transparent, it is herein understood said surface layers "free of any titanium compound." The molded material is utilized in semiconductor fabrication machines and equipment.

With respect to the chlorination degree of the intermediate layer claimed in claim 2, the references do not teach the claimed chlorination content of the vinyl chloride binder. However, Watanabe'520 teaches that the chlorination degree of a polymer will affect is fire resistance, thermal stability, and moldability. Therefore, it would have been obvious to one of ordinary skill in the art at the time the invention was made to control the chlorination degree of the vinyl chloride binder of the intermediate layers. The motivation for doing so would have been to control the laminate's moldability, thermal stability, and fire resistance

Watanabe'520 does not teach that the molded object may be coated on one side with an antistatic composition. However, Sakai teaches a transparent antistatic resin

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molding that comprises a transparent antistatic layer of thermoplastic resin having thickness of 0.15-3.5um in which an entangling ultra-fine long carbon fiber 2-15 wt.% is included in a surface of a transparent thermoplastic base material. The light transmittance is more than 60% and the haze is not more than 20% (abstract). Thus, it would have been obvious to one of ordinary skill in the art at the time the invention was made to surface coat the molding taught in Watanabe'520 with the antistatic layer taught in Sakai. The motivation for doing so would have been to obtain the desired antistatic properties and maintain the transparency of the laminate.

## Response to Arguments

Applicant's arguments with respect to the pending claims have been considered but are most in view of the new ground(s) of rejection.

#### Conclusion

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Kevin R. Kruer whose telephone number is 571-272-1510. The examiner can normally be reached on Monday-Friday.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Carol Chaney can be reached on 571-272-1284. The fax phone number for the organization where this application or proceeding is assigned is 703-872-9306.

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Kevin R. Kruer

H-RX-

Patent Examiner-Art Unit 1773